

### **Features**

- Epitaxial Planar Die Construction
- Halogen Free. "Green" Device (Note 1)
- Moisture Sensitivity Level 1
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# PNP General Purpose Amplifier

# Maximum Ratings @ 25°C Unless Otherwise Specified

Parameter	Symbol	Rating	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V
Collector Current	I <sub>C</sub>	-200	mA
Collector Power Dissipation	Pc	150	mW

### Thermal characteristics

Parameter	Symbol	Rating	Unit
Operating Junction Temperature Range	T <sub>J</sub>	-55~+150	°C
Storage Temperature Range	T <sub>stg</sub>	-55~+150	°C
Thermal Resistance from Junction to Ambient	Rth <sub>(j-a)</sub>	833	°C/W

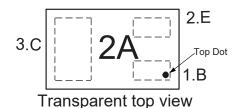
Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

### **Internal Structure**

# 1 - 2

1.BASE 2.EMITTER 3.COLLECTOR

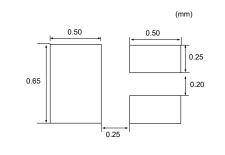
### **Marking Code**



C A1 2 BASE 2. EMITTER 3. COLLECTOR	DFN1006-3		
b	C A 1		
DIMENSIONS	b	1. BASE	

DIMENSIONS					
DIM	INC	INCHES		М	NOTE
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.018	0.022	0.45	0.55	
A1	0.000	0.002	0.00	0.05	
b	0.018	0.022	0.45	0.55	
b1	0.004	0.008	0.10	0.20	
С	0.005	0.007	0.12	0.18	
D	0.037	0.042	0.95	1.075	
E	0.022	0.026	0.55	0.675	
E1	0.006	0.010	0.15	0.25	
е	0.0	26	0.	65	TYP.
L	0.008	0.012	0.20	0.30	
L1	0.0002		0.05		TYP.

### Suggested Solder Pad Layout



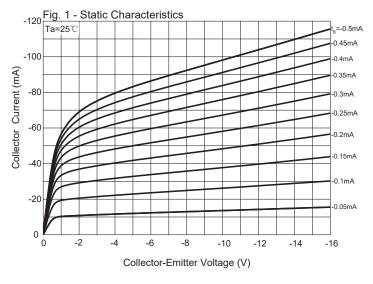


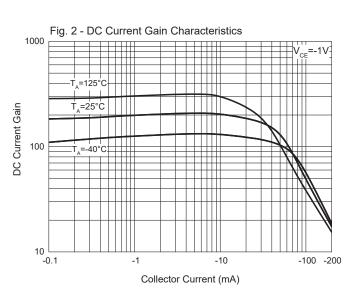
# Electrical Characteristics @ 25°C Unless Otherwise Specified

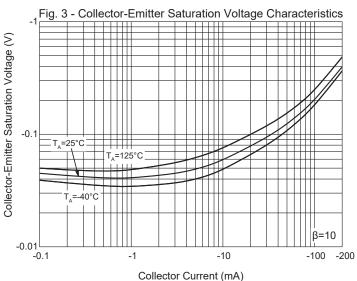
Parameter	Symbol	Min	Тур	Max	Units	Conditions
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-40			V	I <sub>C</sub> =-10μA, I <sub>E</sub> =0
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-40			V	I <sub>C</sub> =-1mA, I <sub>B</sub> =0
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5			V	I <sub>E</sub> =-10μA, I <sub>C</sub> =0
Collector-Base Cutoff Current	I <sub>CBO</sub>			-50	nA	V <sub>CB</sub> =-30V, I <sub>E</sub> =0
Emitter-Base Cutoff Current	I <sub>EBO</sub>			-50	nA	V <sub>EB</sub> =-5V, I <sub>C</sub> =0
	h <sub>FE(1)</sub>	60				V <sub>CE</sub> =-1V, I <sub>C</sub> =-0.1mA
	h <sub>FE(2)</sub>	80				V <sub>CE</sub> =-1V, I <sub>C</sub> =-1mA
DC Current Gain	h <sub>FE(3)</sub>	100		300		V <sub>CE</sub> =-1V, I <sub>C</sub> =-10mA
	h <sub>FE(4)</sub>	60				V <sub>CE</sub> =-1V, I <sub>C</sub> =-50mA
	h <sub>FE(5)</sub>	30				V <sub>CE</sub> =-1V, I <sub>C</sub> =-100mA
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			-0.25	V	I <sub>C</sub> =-10mA, I <sub>B</sub> =-1mA
				-0.4	V	I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA
D F	V <sub>BE(sat)</sub>	-0.65		-0.85	V	I <sub>C</sub> =-10mA, I <sub>B</sub> =-1mA
Base-Emitter Saturation Voltage				-0.95	V	I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA
Transition Frequency	f <sub>T</sub>	250			MHz	V <sub>CE</sub> =-20V, I <sub>C</sub> =-10mA, f=100MHz
Output Capacitance	C <sub>obo</sub>			4.5	pF	V <sub>CB</sub> =-5V, I <sub>E</sub> =0, f=1MHz
Input Capacitance	C <sub>ibo</sub>			10	pF	V <sub>BE</sub> =-0.5V, I <sub>C</sub> =0, f=1KHz
Noise Figure	NF			4 dB	٩D	V <sub>CE</sub> =-5V, I <sub>C</sub> =-100μA
					RS=1KΩ, f=1MHz	
Delay Time	t <sub>d</sub>			35	ns	V <sub>CC</sub> =-3V, V <sub>BE</sub> =-0.5V
Rise Time	t <sub>r</sub>			35	ns	I <sub>C</sub> =-10mA, I <sub>B1</sub> =-1mA
Storage Time	t <sub>s</sub>			225	ns	V <sub>CC</sub> =-3V, I <sub>C</sub> =-10mA
Fall Time	t <sub>f</sub>			75	ns	I <sub>B1</sub> =I <sub>B2</sub> =-1mA

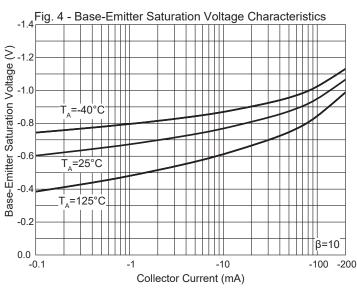


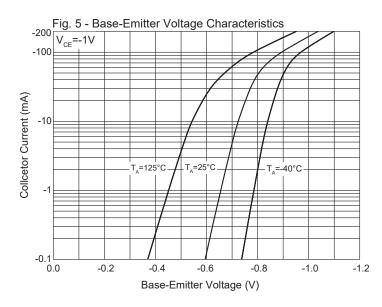
### **Curve Characteristics**

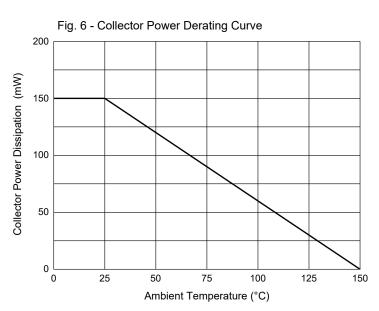














### **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 10Kpcs/Reel

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